Product data sheet

1. General description

AC Thyristor power switch in a SOT223 surface-mountable plastic package with self-protective capabilities against low and high energy transients

2. Features and benefits

- · Common terminal on mounting base allows multiple ACTs on shared cooling pad
- Exclusive negative gate triggering
- · Full cycle AC conduction
- · Remote gate separates the gate driver from the effects of the load current
- Surface-mountable package
- Very high noise immunity
- Safe clamping of low energy over-voltage transients
- Self-protective turn-on during high energy voltage transients

3. Applications

- · Contactors, circuit breakers, valves, dispensers and door locks
- · Fan motor circuits
- · Lower-power highly inductive, resistive and safety loads
- Pump motor circuits

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	I	/lin	Тур	Max	Unit
V_{DRM}	repetitive peak off- state voltage		-		-	600	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{sp} \le 112 ^{\circ}\text{C}$; $\overline{\text{Fig. 1}}$; $\overline{\text{Fig. 2}}$; $\overline{\text{Fig. 3}}$	-		-	0.8	Α
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 16.7 \text{ ms}$	-		-	8.8	Α
		full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 20 \text{ ms}$; Fig. 4; Fig. 5	-		-	8	Α
Tj	junction temperature		-		-	125	°C
V _{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; Fig. 6	-		-	2	kV
Static characte	eristics						
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 100 \text{ mA}; LD+ G-;$ $T_j = 25 \text{ °C}; Fig. 10$	1		-	10	mA

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		V_D = 12 V; I_T = 100 mA; LD- G-; T_j = 25 °C	1	-	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 12</u>	-	9	25	mA
V_{T}	on-state voltage	I _T = 1.1 A; <u>Fig. 13</u>	-	-	1.3	V
V _{CL}	clamping voltage	I_{CL} = 100 μ A; t_p = 1 ms; T_j = 125 °C; Fig. 14	650	-	-	V
Dynamic chara	acteristics					
dV _D /dt	rate of rise of off-state voltage	V _{DM} = 402 V; T _j = 125 °C; gate open circuit; <u>Fig. 15</u>	1000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	V_D = 400 V; T_j = 125 °C; $I_{T(RMS)}$ = 1 A; dV_{com}/dt = 15 V/ μ s; gate open circuit; Fig. 16; Fig. 17	0.3	-	-	A/ms

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	LD	load	4	LD -
2	CM	common		
3	G	gate		G ─0 →
4	СМ	common	⊟1 ⊟2 ⊟3 SC-73 (SOT223)	CM 001aaj924

6. Ordering information

Table 3. Ordering information

Type number		Package					
		Name	Description	Version			
	ACT108W-600E	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223			

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	600	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{sp} \le 112 ^{\circ}\text{C}$; Fig. 1; Fig. 2; Fig. 3	-	0.8	А
I _{TSM}	non-repetitive peak on-	full sine wave; T _{j(init)} = 25 °C; t _p = 16.7 ms	-	8.8	Α
	state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig. 4; Fig. 5	-	8	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	0.32	A²s
dl _T /dt	rate of rise of on-state current	I _G = 20 mA	-	100	A/µs
I _{GM}	peak gate current	t = 20 μs	-	1	Α
V_{GM}	peak gate voltage	positive applied gate voltage	-	15	V
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C
V_{PP}	peak pulse voltage	T _i = 25 °C; non-repetitive, off-state; Fig. 6	-	2	kV

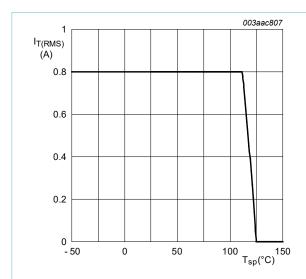


Fig. 1. RMS on-state current as a function of solder point temperature; maximum values

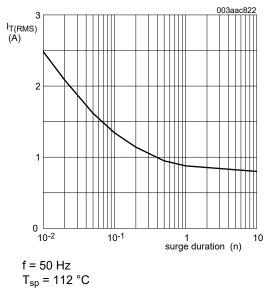


Fig. 2. RMS on-state current as a function of surge duration; maximum values

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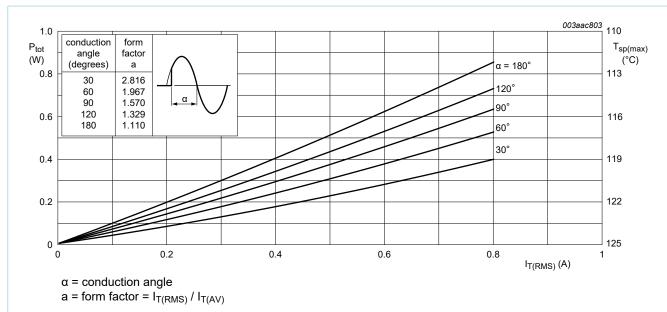


Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values

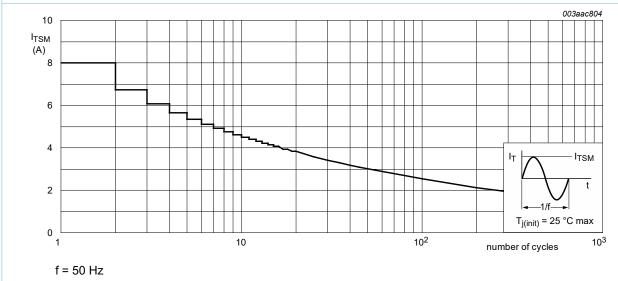
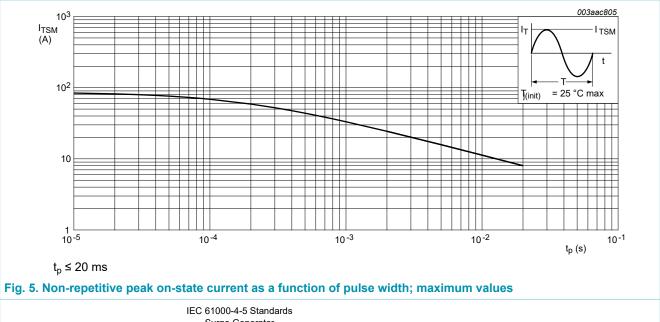


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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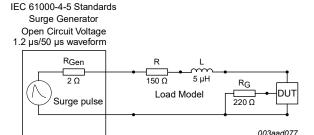
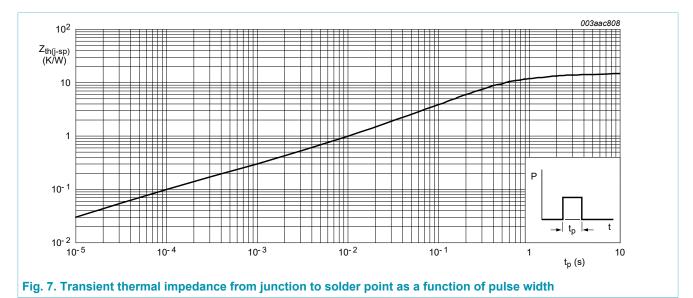


Fig. 6. Test circuit for inductive and resistive loads with conditions equivalent to IEC 61000-4-5

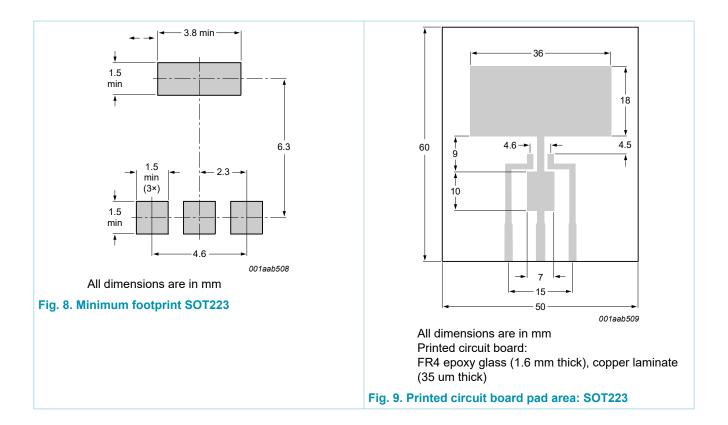
8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point	full cycle with heatsink compound; Fig. 7	-	-	15	K/W
R _{th(j-a)}	thermal resistance from junction to	in free air; printed circuit board mounted; minimum footprint; Fig. 8	-	156	-	K/W
	ambient free air	in free air; printed circuit board mounted; pad area; Fig. 9	-	70	-	K/W



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9. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 100 \text{ mA}; LD+ G-;$ $T_j = 25 \text{ °C}; Fig. 10$	1	-	10	mA
		V_D = 12 V; I_T = 100 mA; LD- G-; T_j = 25 °C	1	-	10	mA
IL	latching current	$V_D = 12 \text{ V}; I_G = 12 \text{ mA}; T_j = 25 ^{\circ}\text{C};$ Fig. 11	-	-	30	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 12</u>	-	9	25	mA
V _T	on-state voltage	I _T = 1.1 A; <u>Fig. 13</u>	-	-	1.3	V
V_{GT}	gate trigger voltage	V _D = 12 V; I _T = 100 mA; T _j = 125 °C	0.15	-	-	V
		V _D = 12 V; I _T = 100 mA; T _j = 25 °C	-	-	1	V
I _D	off-state current	V _D = 600 V; T _j = 125 °C	-	-	0.2	mA
		V _D = 600 V; T _j = 25 °C	-	-	2	μA
V_{CL}	clamping voltage	I_{CL} = 100 μ A; t_p = 1 ms; T_j = 125 °C; Fig. 14	650	-	-	V
Dynamic cl	naracteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T_j = 125 °C; gate open circuit; Fig. 15	1000	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	V_D = 400 V; T_j = 125 °C; $I_{T(RMS)}$ = 1 A; dV_{com}/dt = 15 V/µs; gate open circuit; Fig. 16; Fig. 17	0.3	-	-	A/ms

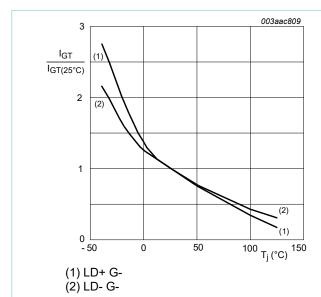


Fig. 10. Normalized gate trigger current as a function of junction temperature

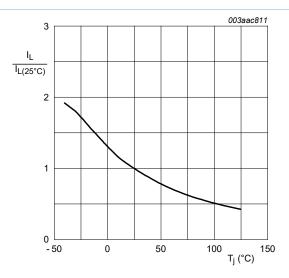


Fig. 11. Normalized latching current as a function of junction temperature

AC Thyristor power switch

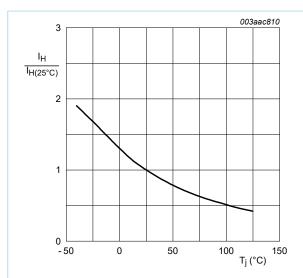
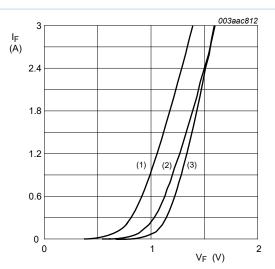


Fig. 12. Normalized holding current as a function of junction temperature



 V_O = 1.044 V; R_S = 0.1526 Ω (1) T_j = 125 °C; typical values (2) T_j = 125 °C; maximum values (3) T_i = 25 °C; maximum values

Fig. 13. On-state current as a function of on-state voltage

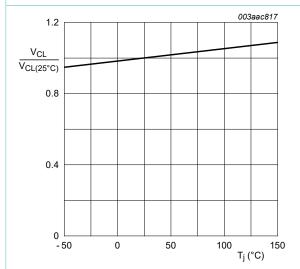
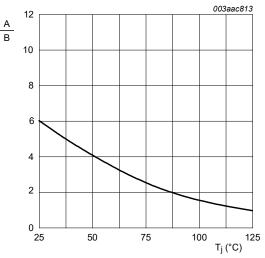


Fig. 14. Normalized clamping voltage (upper limit) as a function of junction temperature; minimum values



A is dV_D/dt at condition T_j °C B is dV_D/dt at condition T_i 125 °C

Fig. 15. Normalized rate of rise of off-state voltage as a function of junction temperature

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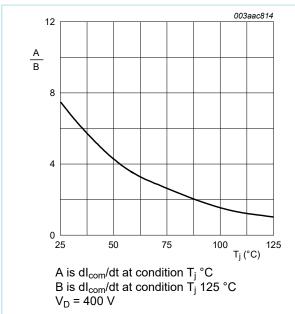


Fig. 16. Normalized critical rate of rise of commutating current as a function of junction temperature

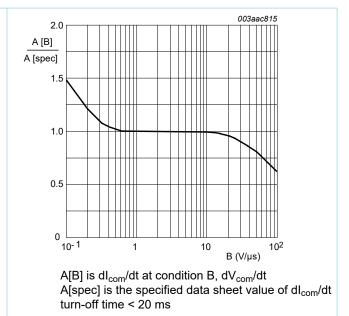


Fig. 17. Normalized critical rate of change of commutating current as a function of critical rate of change of commutating voltage; minimum values

10. Package outline

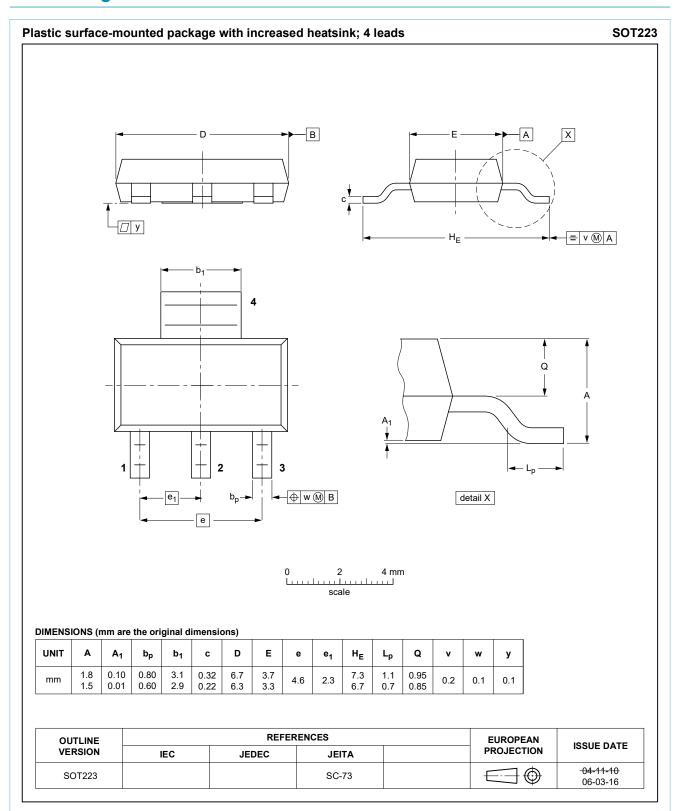
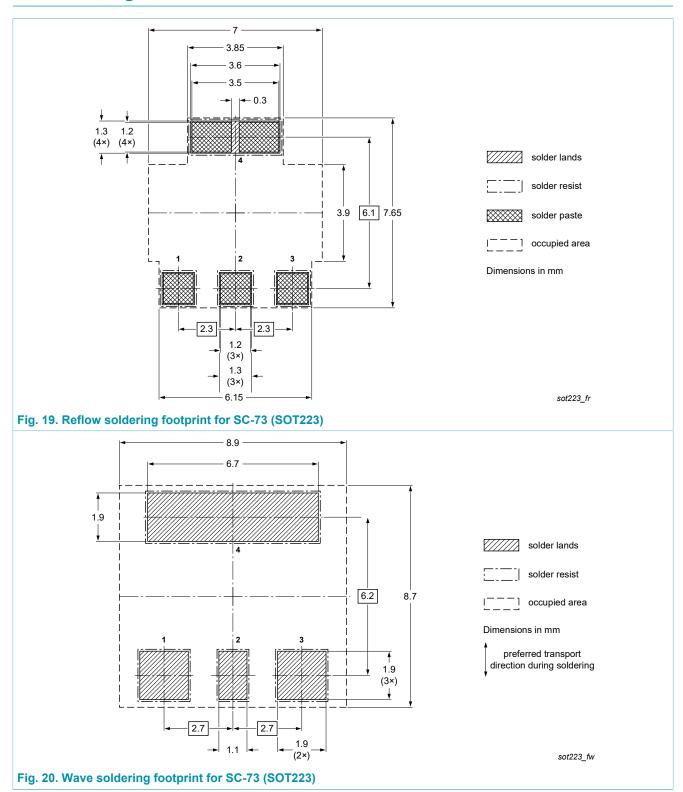


Fig. 18. Package outline SC-73 (SOT223)

11. Soldering



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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